S/N 09/945535

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Kie Y. Ahn et al.

Examiner:

David Blum

2813

Serial No .:

09/945535

Group Art Unit:

Filed:

August 30, 2001

Docket:

1303.026US1

Title:

HIGHLY RELIABLE AMORPHOUS HIGH-K GATE OXIDE ZrO2

INFORMATION DISCLOSURE STATEMENT

ssistant Commissioner for Patents

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Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Information Disclosure Statement.

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, P.O.Box 1450, Alexandria, VA 22313-1450, on this 10th day of June, 2003

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Inder the Paperwork Reduction Act of 1985, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE 09/945535 **Application Number** STATEMENT BY APPLICANT (Use as many sheets as recessary) LECHNOL **Filing Date** August 30, 2001 JUN 1 2 2003 Ahn, Kie **First Named Inventor** 召 2813 **Group Art Unit Examiner Name** Blum, David Attorney Docket No: 1303.026US1 Sheet 1 of 3

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